

SIS3302 100 MHz 16-bit VME Digitizer

User Manual

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Revision Table:

Revision	Date	Modification
0.01	18.03.06	Generation from SIS3320
0.04	08.06.06	Th
0.05	13.06.06	MKI workup
0.06	16.06.06	Definition of airflow
1.00	23.06.06	First official release
1.01	03.07.07	Bug fixes in interrupt control register
1.02	18.10.07	DAC load sequence diagram
1.03	04.02.08	Design Version: 010B New Features: <ul style="list-style-type: none">- Average Mode (2,4,8, ..., 128)- 48-bit Timestamp- Leading edge trigger
1.04	14.02.08	Design Version: 010C Bug fix: odd VME IRQs
1.05	01.07.08	Design Version: 010D New clock source: Second internal 100 MHz
1.06	17.08.08	Firmware comment for 2 nd internal 100 MHz
1.07	24.11.08	Bug fix in sample length register description
1.08	10.12.08	Design Version: 010E New Features: <ul style="list-style-type: none">- ADC value order programmable (little/big endian)
1.09	10.07.09	Bug fix in broadcast setup

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1 Introduction

The SIS3302 is an eight channel ADC/digitizer board with a sampling rate of up to 100 MHz (for the individual channel) and a resolution of 16-bit. The board is a single width 6U VME card, which has no special (i.e. non standard VME) voltage requirements.

The flexible combination of DDR2 memory technology data storage in combination with FPGA based data handling/movement allows for a generic design which covers a variety of applications.

Applications comprise but are not limited to:

- digitization of “slow” detectors like calorimeters
- accelerator/machine controls



As we are aware, that no manual is perfect, we appreciate your feedback and will try to incorporate proposed changes and corrections as quickly as possible. The most recent version of this manual can be obtained by email from info@struck.de, the revision dates are online under <http://www.struck.de/manuals.htm>.

1.1 Related documents

A list of available firmware designs can be retrieved from <http://www.struck.de/sis3302firm.htm>



2 Technical Properties/Features

2.1 Key functionality

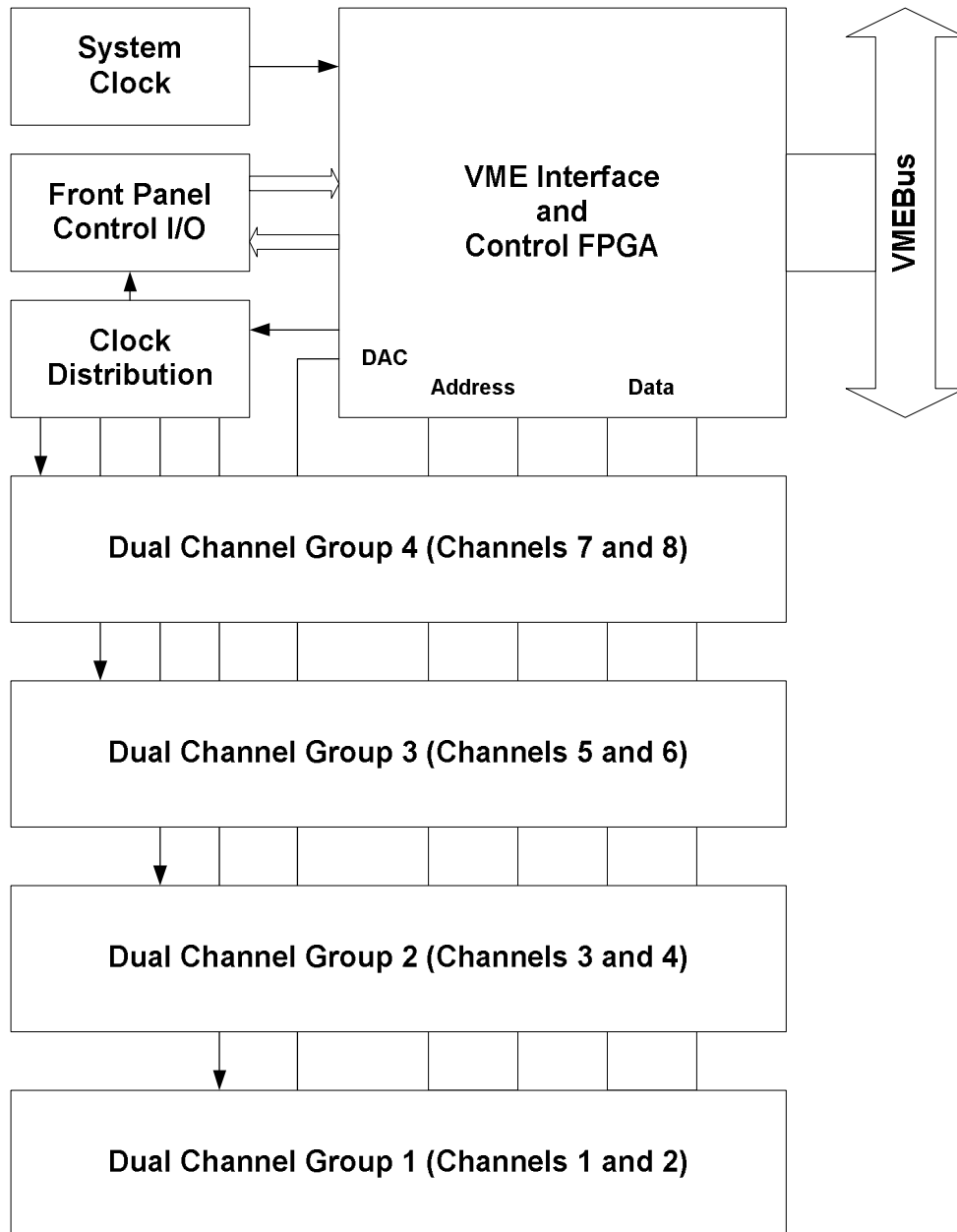
Find below a list of key features of the SIS3302 digitizer.

- 8 channels
- 16-bit resolution
- 32 MSamples/channel memory
- external clock range 1 ... 100 MHz
- special clock mode (random external clock)
- external/internal clock
- input bandwidth 50 MHz
- offset DACs
- multi event mode
- read on the fly (actual sample value)
- pre/post trigger option
- readout in parallel to acquisition
- trigger generation (FIR trigger)
- 4 NIM control inputs/4 NIM control outputs
- A32 D32/BLT32/MBLT64/2eVME/2eSST
- Hot swap (in conjunction with VME64x backplane)
- VME64x Connectors
- VME64x Front panel
- VME64x extractor handles (on request)
- F1002 compatible P2 row A/C assignment
- +5 V, +12V and -12 V VME standard voltages
- LEMO00, SMA or LEMO 0S (differential) analog input connectors
- default input span of 5V (can be shifted with DAC to accomplish input range settings like +2.5 V, ... -2.5 V e.g.)

Note: The SIS3302 shall not be operated on P2 row A/C extensions, like VSB e.g. due to the compatibility to the F1002 FADC modules clock and start/stop distribution scheme.

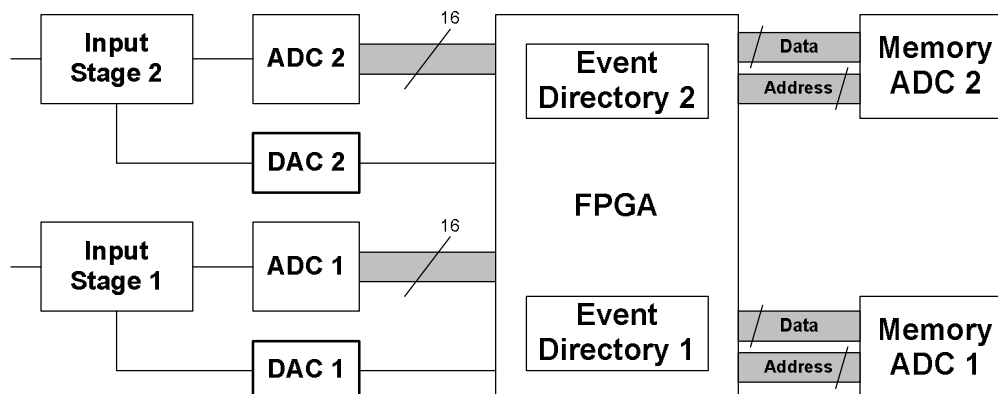
2.2 Module design

The SIS3302 consists of four identical groups of 2 ADC channels each and a control section as shown in the simplified block diagram below.



2.2.1 Dual channel group

Two ADC channels form a group, which memory is handled by one Field Programmable Gate Array (FPGA).



2.3 Modes of Operation

The SIS3302 was developed with maximum flexibility in mind. The FPGA based design of the card allows to meet the requirements of many readout applications with dedicated firmware designs in the future. The initial firmware is supposed to furnish you with an easy to use yet powerful high speed high resolution Flash Analog to Digital Converter (FADC) implementation, that covers many everyday analog to digital applications.

2.4 Memory management

The memory can be used either as one contiguous memory or as a subdivided multi event memory. In addition memory depth can be limited in single event operation to match the requirements of the given application.

2.4.1 Single Event Mode

The full memory of 32 MSamples of the SIS3302 is used as one big circular buffer or as single shot memory in single event mode, unless memory size is limited by the event configuration register.

2.4.2 Multi Event Mode

The memory can be divided in pages or events to make the acquisition of shorter signals more efficient. Up to 512 stop pointers for the individual page can be retrieved from the event directory. In auto start mode the ADC advances to the next page and starts sampling automatically.

2.5 Clock sources

The SIS3302 features the two basic clock modes

- Internal clock
- External symmetric clock
- Random external clock

2.5.1 Internal clock

The internal clock is generated from an on board 50 MHz quartz. It is either doubled or prescaled to generate 100 MHz or lower clock speeds respectively. A 100 MHz quartz is available as 2nd internal 100 MHz clock source from firmware revision 0x010D on with the corresponding stuffing option (i.e. U212 stuffed with a 100 MHz 3.3 V oscillator, Struck part number 02954)

Internal clock speeds
100 MHz
Second 100 MHz (0x010D)
50 MHz
25 MHz
10 MHz
1 MHz

For optimum internal clock speed resolution the use of the “Second internal 100 MHz” instead of “internal 100 MHz is recommended.

Prerequisites for the availability of the 2nd 100 MHz:

- 1.) U212 stuffed with a 100 MHz 3.3 V oscillator
- 2.) Firmware revision 0x010D or higher

2.5.2 External clock

A symmetric external clock (NIM level, ratio between 45:55 and 55:45) can be fed to the module through a LEMO00 connector. An ECL clock over rows A/C of the J2 VME backplane is prepared but not implemented. For optimum performance the clock frequency should be within the specified range for the given ADC chip.

Module	Min. sym. clock	Max sym. clock
SIS3302-100	1 MHz	100 MHz

Lower sampling speeds are possible in random external clock mode.

2.6 Trigger control (pre/post, start/stop mode)

The SIS3302 features pre/post trigger capability as well as start/stop mode .
The trigger behaviour is defined by the acquisition control register.

2.7 Internal Trigger generation

The trigger output of the SIS3302 can be either used to interact with external trigger logic or to base start/stop on a threshold (i.e. one individual threshold per ADC channel) of the digitized data. Trigger generation can be activated with two conditions:

- module armed (i.e. sample clock active, trigger can be used to start acquisition)
- module armed and started (trigger can be used to stop acquisition)

The user can select between triggering on the conditions above and below threshold

The trigger is formed with a trapezoidal FIR filter..

2.8 VME Interrupts

Two registers, the Interrupt configuration and the Interrupt control register, are implemented for interrupt setup and control.

Two interrupt sources are implemented:

- End of Event
- End of Last Event in Multi Event mode

3 VME Addressing

As the SIS3302 VME FADC features memory options with up to 8 times 32 MSamples, A32 addressing was implemented as the only option. The module occupies an address space of 0x7FFFFFFF Bytes, i.e. 128 MBytes are used by the module.

The base address is defined by the selected addressing mode, which is selected by jumper array JP80 and SW1 and SW2 (in non geographical mode).

The table below summarises the possible base address settings.

J1 Setting			Bits				
A32	GEO	VIPA	31	30	29	28	27
x			SW1				SW2=0...7 Bit 27=0
x			SW1				SW2=8...F Bit 27=1
x	x		Not implemented in this design				
		x	Not implemented in this design				

Shorthand	Explanation
SW1/SW2	Setting of rotary switch SW1 or SW2 respective

Notes:

- This concept allows the use of the SIS3302 in standard VME as well as in VME64x environments, i.e. the user does not need to use a VME64x backplane.
- The factory default setting is EN_A32 closed, SW1=3, SW2=0 (i.e. the module will react to A32 addressing under address 0x30000000). With more than one unit shipped in one batch a set of addresses (like 0x10000000, 0x20000000, 0x30000000,...) may be used also.

3.1 Address Map

The SIS3302 resources and their locations are listed in the table below.

Note: Write access to a key address (KA) with arbitrary data invokes the respective action

Offset	Size in Bytes	BLT	Access	Function
0x00000000	4	-	W/R	Control/Status Register (J-K register)
0x00000004	4	-	R	Module Id. and Firmware Revision register
0x00000008	4	-	R/W	Interrupt configuration register
0x0000000C	4	-	R/W	Interrupt control register
0x00000010	4	-	R/W	Acquisition control/status register (J-K register)
0x00000014	4	-	R/W	Extern Start Delay register
0x00000018	4	-	R/W	Extern Stop Delay register
0x00000020			R/W	Max. Nof Events Register
0x00000024			R	Actual Event Counter
0x00000030	4	-	R/W	CBLT/Broadcast Setup register
0x00000034	4	-	R/W	ADC Memory Page register
0x00000050	4	-	R/W	DAC Control Status register
0x00000054	4	-	R/W	DAC Data register
0x00000060			R/W	XILINX JTAG_TEST/JTAG_DATA_IN
0x00000064			W	XILINX JTAG_CONTROL
0x00000400	4	-	KA W	Key General Reset
0x00000410	4	-	KA W	Key Arm Sampling Logic
0x00000414	4	-	KA W	Key Disarm Sampling Logic
0x00000418	4	-	KA W	Key sampling
0x0000041C	4	-	KA W	Key Stop sampling
0x0000042C	4	-	KA W	Key Timestamp Clear
0x00010000	0x1000	D32, BLT32	R	Event Timestamp directory

Event information all ADC groups				
0x01000000	4	-	W only	Event configuration register (all ADCs)
0x01000004	4	-	W only	Event Length register (all ADCs)
0x01000008	4	-	W only	Sample Start address register (all ADCs)
0x0100000C	4	-	W only	ADC input mode register (all ADCs)

Event information ADC group 1				
0x02000000	4	-	R/W	Event configuration register (ADC1, ADC2)
0x02000004	4	-	R/W	Event Length register (ADC1, ADC2)
0x02000008	4	-	R/W	Sample Start address register (ADC1, ADC2)
0x0200000C	4	-	R/W	ADC input mode register (ADC1, ADC2)
0x02000010	4	-	R	Next Sample address register ADC1
0x02000014	4	-	R	Next Sample address register ADC2
0x02000020	4	-	R	Actual Sample Value (ADC1, ADC2)
0x02000024	4	-	R	internal Test register
0x02000028	4	-	R	DDR2 Memory Logic Verification register (ADC1, ADC2)
0x0200002C	4	-	R/W	Trigger Flag Clear Counter register (ADC1, ADC2)
0x02000030	4	-	R/W	ADC1 Trigger setup register
0x02000034	4	-	R/W	ADC1 Trigger Threshold register
0x02000038	4	-	R/W	ADC2 Trigger setup register
0x0200003C	4	-	R/W	ADC2 Trigger Threshold register
0x02010000	0x800	D32, BLT32	R	Event directory ADC1
0x02018000	0x800	D32, BLT32	R	Event directory ADC2

Event information ADC group 2				
0x02800000	4	-	R/W	Event configuration register (ADC3, ADC4)
And so on (as for ADC group 1)				

Event information ADC group 3				
0x03000000	4	-	R/W	Event configuration register (ADC5, ADC6)
And so on (as for ADC group 1)				

Event information ADC group 4				
0x03800000	4	-	R/W	Event configuration register (ADC7, ADC8)
And so on (as for ADC group 1)				

ADC memory pages				
0x04000000	8 MByte	X	R	ADC 1 memory page
0x04800000	8 MByte	X	R	ADC 2 memory page
0x05000000	8 MByte	X	R	ADC 3 memory page
0x05800000	8 MByte	X	R	ADC 4 memory page
0x06000000	8 MByte	X	R	ADC 5 memory page
0x06800000	8 MByte	X	R	ADC 6 memory page
0x07000000	8 MByte	X	R	ADC 7 memory page
0x07800000	8 MByte	X	R	ADC 8 memory page

Note 2: MBLT64, 2eVME and 2eSST read access is supported from memory (i.e. not from register space) only.

4 Register Description

The function of the individual registers is described in detail in this section.

The first line after the subsection header (in Courier font) like:

```
#define SIS3302_CONTROL_STATUS      0x0      /* read/write; D32 */
refers to the sis3302.h header file.
```

4.1 Control/Status Register(0x, write/read)

```
#define SIS3302_CONTROL_STATUS      0x0      /* read/write; D32 */
```

The control register is implemented as a selective J/K register, a specific function is enabled by writing a 1 into the set/enable bit, the function is disabled by writing a 0 into the clear/disable bit (which location is 16-bit higher in the register). An undefined toggle status will result from setting both the enable and disable bits for a specific function at the same time. The only function at this point in time is user LED on/off.

On read access the same register represents the status register.

Bit	write Function	read Function
31	Clear reserved 15 (*)	0
30	Clear reserved 14 (*)	0
29	Clear reserved 13 (*)	0
28	Clear reserved 12 (*)	0
27	Clear reserved 11 (*)	0
26	Clear reserved 10 (*)	0
25	Clear reserved 9 (*)	0
24	Clear reserved 8 (*)	0
23	Clear reserved 7 (*)	0
22	Clear reserved 6 (*)	0
21	Clear reserved 5 (*)	0
20	Clear reserved 4 (*)	0
19	Clear reserved 3 (*)	0
18	Clear reserved 2 (*)	0
17	Clear reserved 1 (*)	0
16	Switch off user LED (*)	0
15	Set reserved 15	Status reserved 15
14	Set reserved 14	Status reserved 14
13	Set reserved 13	Status reserved 13
12	Set reserved 12	Status reserved 12
11	Set reserved 11	Status reserved 11
10	Set reserved 10	Status reserved 10
9	Set reserved 9	Status reserved 9
8	Set reserved 8	Status reserved 8
7	Set reserved 7	Status reserved 7
6	Set reserved 7	Status reserved 6
5	Set reserved 7	Status reserved 4
4	Set reserved 7	Status reserved 4
3	Set reserved 3	Status reserved 3
2	Set reserved 2	Status reserved 2
1	Set reserved 1	Status reserved 1
0	Switch on user LED	Status User LED (1=LED on, 0=LED off)

(*) denotes power up default setting

4.2 Module Id. and Firmware Revision Register (0x4, read)

```
#define SIS3302_MODID          0x4          /* read only; D32 */
```

This register reflects the module identification of the SIS3302 and its minor and major firmware revision levels. The major revision level will be used to distinguish between substantial design differences and experiment specific designs, while the minor revision level will be used to mark user specific adaptations.

Bit	Function	Reading
31	Module Id. Bit 15	3
30	Module Id. Bit 14	
29	Module Id. Bit 13	
28	Module Id. Bit 12	
27	Module Id. Bit 11	3
26	Module Id. Bit 10	
25	Module Id. Bit 9	
24	Module Id. Bit 8	
23	Module Id. Bit 7	0
22	Module Id. Bit 6	
21	Module Id. Bit 5	
20	Module Id. Bit 4	
19	Module Id. Bit 3	2
18	Module Id. Bit 2	
17	Module Id. Bit 1	
16	Module Id. Bit 0	
15	Major Revision Bit 7	
14	Major Revision Bit 6	
13	Major Revision Bit 5	
12	Major Revision Bit 4	
11	Major Revision Bit 3	
10	Major Revision Bit 2	
9	Major Revision Bit 1	
8	Major Revision Bit 0	
7	Minor Revision Bit 7	
6	Minor Revision Bit 6	
5	Minor Revision Bit 5	
4	Minor Revision Bit 4	
3	Minor Revision Bit 3	
2	Minor Revision Bit 2	
1	Minor Revision Bit 1	
0	Minor Revision Bit 0	

4.2.1 Major revision numbers

Find below a table with major revision numbers used to date

Major revision number	Application/user
0x01	Generic designs
0x20	Gamma design

4.3 Interrupt configuration register (0x8)

```
#define SIS3302_IRQ_CONFIG      0x8      /* read/write; D32 */
```

This read/write register controls the VME interrupt behaviour of the SIS3302 ADC. Four interrupt sources are foreseen, for the time being three of them are associated with an interrupt condition, the fourth condition is reserved for future use.

The interrupter type is DO8 .

4.3.1 IRQ mode

In RORA (release on register access) mode the interrupt will be pending until the IRQ source is cleared by specific access to the corresponding disable VME IRQ source bit. After the interrupt is serviced the source has to be activated with the enable VME IRQ source bit again.

In ROAK (release on acknowledge) mode , the interrupt condition will be cleared (and the IRQ source disabled) as soon as the interrupt is acknowledged by the CPU. After the interrupt is serviced the source has to be activated with the enable VME IRQ source bit again.

Bit	Function	Default
31		0
...		0
16		0
15		0
14		0
13		0
12	RORA/ROAK Mode (0: RORA; 1: ROAK)	0
11	VME IRQ Enable (0=IRQ disabled, 1=IRQ enabled)	0
10	VME IRQ Level Bit 2	0
9	VME IRQ Level Bit 1	0
8	VME IRQ Level Bit 0	0
7	IRQ Vector Bit 7; placed on D7 during VME IRQ ACK cycle	0
6	IRQ Vector Bit 6; placed on D6 during VME IRQ ACK cycle	0
5	IRQ Vector Bit 5; placed on D5 during VME IRQ ACK cycle	0
4	IRQ Vector Bit 4; placed on D4 during VME IRQ ACK cycle	0
3	IRQ Vector Bit 3; placed on D3 during VME IRQ ACK cycle	0
2	IRQ Vector Bit 2; placed on D2 during VME IRQ ACK cycle	0
1	IRQ Vector Bit 1; placed on D1 during VME IRQ ACK cycle	0
0	IRQ Vector Bit 0; placed on D0 during VME IRQ ACK cycle	0

The power up default value reads 0x 00000000

4.4 Interrupt control register (0xC)

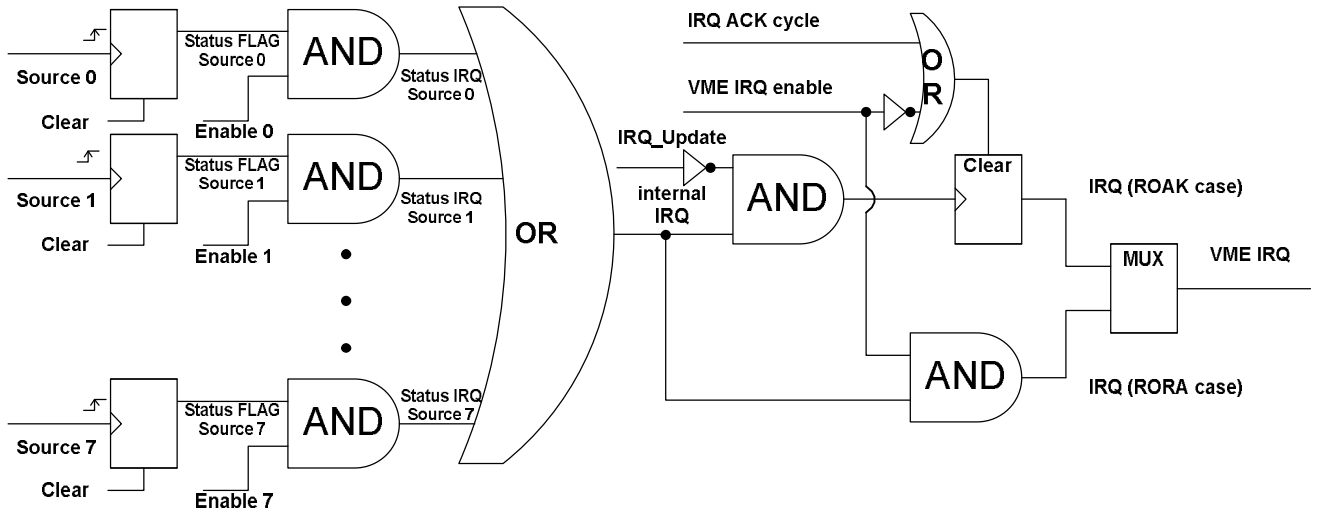
```
#define SIS3302_IRQ_CONTROL          0xC          /* read/write; D32 */
```

This register controls the VME interrupt behaviour of the SIS3302 ADC. Eight interrupt sources are foreseen, for the time being two of them are associated with an interrupt condition, the others are reserved for future use.

Bit	Function (w)	(r)	Default
31	Update IRQ Pulse	Status IRQ source 7 (reserved)	0
30	unused	Status IRQ source 6 (reserved)	0
29	unused	Status IRQ source 5 (reserved)	0
28	unused	Status IRQ source 4 (reserved)	0
27	unused	Status IRQ source 3 (reserved)	0
26	unused	Status IRQ source 2 (reserved)	0
25	unused	Status IRQ source 1 (End of Last Event in Multi Event mode; edge sensitive)	0
24	unused	Status IRQ source 0 (End of Event; edge sensitive)	0
23	Disable/Clear IRQ source 7	Status flag source 7	0
22	Disable/Clear IRQ source 6	Status flag source 6	0
21	Disable/Clear IRQ source 5	Status flag source 5	0
20	Disable/Clear IRQ source 4	Status flag source 4	0
19	Disable/Clear IRQ source 3	Status flag source 3	0
18	Disable/Clear IRQ source 2	Status flag source 2	0
17	Disable/Clear IRQ source 1	Status flag source 1	0
16	Disable/Clear IRQ source 0	Status flag source 0	0
15	unused	Status VME IRQ	0
14	unused	Status internal IRQ	0
13	unused	0	0
12	unused	0	0
11	unused	0	0
10	unused	0	0
9	unused	0	0
8	unused	0	0
7	Enable IRQ source 7	Status enable source 7 (read as 1 if enabled, 0 if disabled)	0
6	Enable IRQ source 6	Status enable source 6 (read as 1 if enabled, 0 if disabled)	0
5	Enable IRQ source 5	Status enable source 5 (read as 1 if enabled, 0 if disabled)	0
4	Enable IRQ source 4	Status enable source 4 (read as 1 if enabled, 0 if disabled)	0
3	Enable IRQ source 3	Status enable source 3 (read as 1 if enabled, 0 if disabled)	0
2	Enable IRQ source 2	Status enable source 2 (read as 1 if enabled, 0 if disabled)	0
1	Enable IRQ source 1	Status enable source 1 (read as 1 if enabled, 0 if disabled)	0
0	Enable IRQ source 0	Status enable source 0 (read as 1 if enabled, 0 if disabled)	0

The power up default value reads 0x00000000

The generation of the status flags, the IRQ flags and the actual IRQ is illustrated with the schematic below:



- IRQ source 0: End of Event
- IRQ source 1: End of Last Event in Multi Event mode (disarm)
- IRQ source 2: reserved
- IRQ source 3: reserved

- IRQ source 4: reserved
- IRQ source 5: reserved
- IRQ source 6: reserved
- IRQ source 7: reserved

4.5 Acquisition control register (0x10, read/write)

```
#define SIS3302_ACQUISTION_CONTROL    0x10    /* read/write; D32 */
```

The acquisition control register is in charge of most of the settings related to the actual configuration of the digitization process.

Like the control register it is implemented in a J/K fashion.

Bit	Write Function	Read
31	Clear reserved 15 (*)	0
30	Clear Clock Source Bit2	0
29	Clear Clock Source Bit1	0
28	Clear Clock Source Bit0	0
27	Clear ADC value order big endian (*)	0
26	Clear reserved 10 (*)	0
25	Disable front panel Lemo Timestamp_Clear (Lemo In 1) (*)	0
24	Disable front panel LEMO start/stop logic	0
23	Clear reserved 7 (*)	0
22	Disable internal trigger as stop (*)	0
21	Disable Multi Event mode (*)	0
20	Disable Autostart mode (*)	0
19	Clear reserved 3 (*)	0
18	Clear reserved 2 (*)	0
17	Clear reserved 1 (*)	ADC Sampling Busy
16	Clear reserved 0 (*)	ADC Sampling Logic Armed
15	Set reserved 15	Status reserved 15
14	Set clock source Bit 2	Status clock source Bit 2
13	Set clock source Bit 1	Status clock source Bit 1
12	Set clock source Bit 0	Status clock source Bit 0
11	Set ADC value order big endian	Status ADC value order big endian
10	Set reserved 10	Status reserved 10
9	Enable front panel Lemo Timestamp_Clear (Lemo In 1)	Status Enable front panel Lemo Timestamp_Clear
8	Enable front panel Lemo Start/Stop logic	Status Enable front panel start/stop logic
7	Set reserved 7	Status reserved 7
6	Enable internal trigger as stop	Status internal trigger as stop
5	Enable Multi Event mode	Status Multi Event mode
4	Enable Autostart mode	Status Autostart mode
3	Set reserved 3	Status reserved 3
2	Set reserved 2	Status reserved 2
1	Set reserved 1	Status reserved 1
0	Set reserved 0	Status reserved 0

The power up default value reads 0x0

Clock source bit setting table:

Clock Source Bit2	Clock Source Bit1	Clock Source Bit0	Clock Source
0	0	0	internal 100 MHz
0	0	1	internal 50 MHz
0	1	0	internal 25 MHz
0	1	1	internal 10 MHz
1	0	0	internal 1 MHz
1	0	1	external random clock mode (internal 100 MHz)
1	1	0	external clock (LEMO front panel) ; min. 1 MHz
1	1	1	Second internal 100 MHz

Note:

The internal 100 MHz is generated with a DLL in the FPGA from the internal 50 MHz. For optimum resolution use the “Second internal 100 MHz” instead of “internal 100 MHz”. (U212 must be assembled with a 100 MHz 3.3 V oscillator)

Multi Event mode :

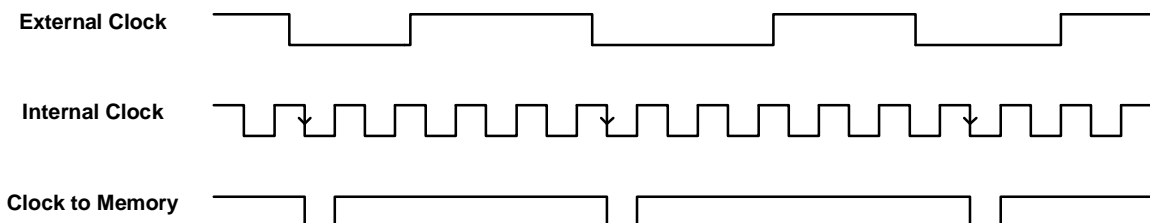
- 0 : Sampling Logic Armed state will be cleared at end of event
- 1 : Sampling Logic Armed state will be cleared at end of last event (defined with Max_Nof_Events register)

Autostart mode:

- 0 : The Sampling will start when the Sampling Logic is armed and a START is issued (external LEMO or VME KEY command).
- 1 : With Multi Event Mode enabled sampling will start with the Sampling Logic Arm command (VME KEY command) and with end of Event. to start sampling. Sampling will start in the next page in the latter case.

External random clock mode :

This mode allows for sampling at arbitrary low and non symmetric external clock. The digitizer is set up for internal clock and will strobe one datum to memory with the leading edge of the internal clock cycle that follows the leading edge of an external clock pulse as illustrated below. Pipelining between the actual analog input signal and the value stored to memory has to be taken into account.



ADC value order big endian mode:

- 0 : The ADC value readout order is little endian
- 1 : The ADC value readout order is big endian

(see ADC Memory Data Format)

4.6 Start Delay register (0x14, read/write)

```
#define SIS3302_START_DELAY    0x14    /* read/write; D32 */
```

Pretrigger operation can be implemented via the start delay register in conjunction with front panel start/stop mode operation. The external Start Signal and the Autostart Signal will be delayed by the value of the register .

Bit	
31	unused, read as 0
...	
24	unused, read as 0
23	START_DELAY_BIT23
..	
..	
0	START_DELAY_BIT0

The power up default value is 0

4.7 Stop Delay register (0x18, read/write)

```
#define SIS3302_STOP_DELAY    0x18    /* read/write; D32 */
```

Posttrigger operation can be implemented via the stop delay register in conjunction with front panel start/stop mode operation. The external stop signal and the internal trigger (if enabled) will be delayed by the value of the register .

Bit	
31	unused, read as 0
...	
24	unused, read as 0
23	STOP_DELAY_BIT23
..	
..	
0	STOP_DELAY_BIT0

The power up default value is 0

4.8 Max_Nof_Events_Register (0x20, read/write)

```
#define SIS3302_MAX_NOF_EVENT          0x20          /* read/write; D32 */
```

The Sampling Logic will be disarmed In Multi Event mode as soon as the Event counter reaches the value of the Max_Nof_Events register.

Bit	
31	unused, read as 0
...	
20	unused, read as 0
19	MAX NOF Events Bit19
..	
..	
0	MAX NOF Events Bit 0

The power up default value is 0

4.9 Actual_Event_Counter (0x24, read)

```
#define SIS3302_ACTUAL_EVENT_COUNTER  0x24          /* read; D32 */
```

This register holds the actual number of events in multi event mode.
The Event Counter is cleared when the Sampling Logic is armed and it is incremented with every start sampling.

Bit	
31	unused, read as 0
...	
20	unused, read as 0
19	Actual event counter Bit 19
..	
..	
0	Actual event counter Bit 0

The power up default value is 0

4.10 CBLT/Broadcast setup register

```
#define SIS3302_CBLT_BROADCAST_SETUP      0x30      /* read/write; D32 */
```

The CBLT feature is not implemented yet (as of firmware 01 06).

This read/write register defines, whether the SIS3302 will participate in a Broadcast. The configuration of this register and the registers of other participating modules is essential for proper Broadcast behaviour.

Bit	Function
31	CBLT/Broadcast address bit 31
30	CBLT/Broadcast address bit 30
29	CBLT/Broadcast address bit 29
28	CBLT/Broadcast address bit 28
27	CBLT/Broadcast address bit 27
26	reserved
25	reserved
24	reserved
23	reserved
22	reserved
21	reserved
20	reserved
19	reserved
18	reserved
17	reserved
16	reserved
15	reserved
14	reserved
13	reserved
12	reserved
11	reserved
10	0
9	0
8	0
7	0
6	0
5	Enable Broadcast Master
4	Enable Broadcast
3	0
2	reserved
1	reserved
0	reserved

4.11 ADC Memory Page register

```
#define SIS3302_ADC_MEMORY_PAGE_REGISTER 0x34 /* read/write; D32 */
```

The SIS3302 default memory size per channel is 64 MByte (i.e. 32 MSample).

The VME address space window per ADC is limited to 8 MByte (4 MSample) however. The read/write ADC memory page register is used to select one of the 8 memory subdivisions (pages).

Bit	Function
31	reserved
..	
..	
4	reserved
3	Page register bit 3 (reserved)
2	Page register bit 2
1	Page register bit 1
0	Page register bit 0

Example: readout routine for 32MSample readout
(see `sis3302_single_event_sample_wrap_test1.c`)

```
int sis3302_Read_ADC_Channel( unsigned int module_address,
                             unsigned int vme_read_mode,
                             unsigned int adc_channel /* 0 to 7 */,
                             unsigned int event_sample_start_addr,
                             unsigned int event_sample_length,
                             unsigned int* uint_adc_buffer)
```


4.12 DAC Control Registers

This set of registers is used to program the 16-bit offset DACs for the 8 ADC channels. Refer to the documentation of the AD5570 DAC chip for details also and have a look to the configuration example in `sis3302_adc_test1.c` (CVI directory)

Example routine:

```
int sis3302_write_dac_offset( unsigned int module_addr,
                             unsigned int *offset_value_array)
```

4.12.1 DAC Control/Status register (read/write)

```
#define SIS3302_DAC_CONTROL_STATUS 0x50 /* read/write; D32 */
```

Bit	Write Function	Read Function
31	None	0
..
..
16	None	0
15	None	DAC Read/Write/Clear Cycle BUSY
14	None	0
...		...
8	None	0
7	None	0
6	DAC selection Bit 2	status of DAC selection Bit 2
5	DAC selection Bit 1	status of DAC selection Bit 1
4	DAC selection Bit 0	status of DAC selection Bit 0
3
2	none	0
1	DAC Command Bit 1	DAC Command Bit 1 Status
0	DAC Command Bit 0	DAC Command Bit 0 Status

DAC Command Bit

Bit 1	Bit 0	Function
0	0	No function
0	1	Load shift register of selected DAC
1	0	Load selected DAC
1	1	Clear all DACs

A “Clear DAC” command (issued after power up automatically) sets the value of all DACs to analog ground.

4.12.2 DAC Data register (read/write)

```
#define SIS3302_DAC_DATA          0x54          /* read/write; D32 */
```

Bit	Write Function	Read Function
31	none	DAC Input Register Bit 15 (from DAC)
..
..
16	none	DAC Input Register Bit 0
15	DAC Output Register Bit 15	DAC Output Register Bit 15
..	..	0
..	..	0
0	DAC Output Register Bit 0	DAC Output Register Bit 0

4.12.3 DAC load sequence (read/write)

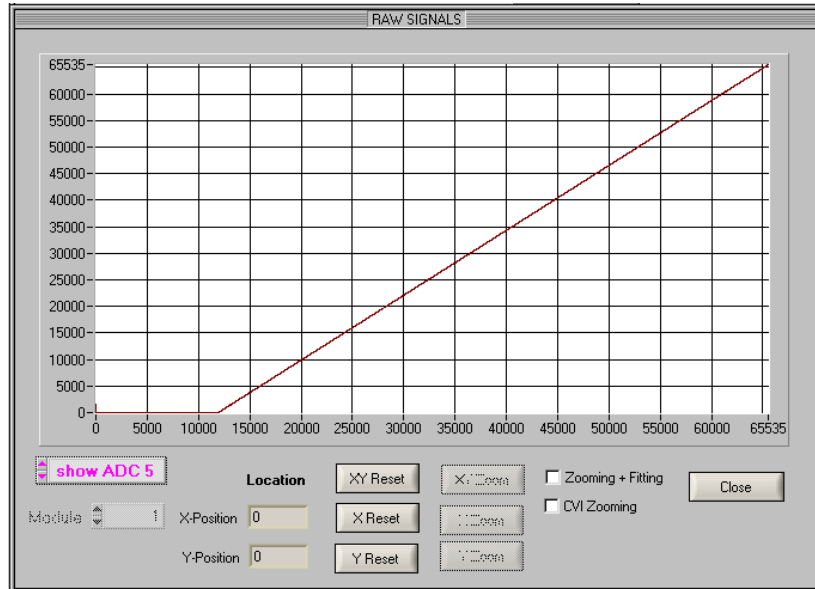
The sequence to load the DAC of a single channel is shown below.

The example routine `sis3302_write_dac_offset` loads the 8 DACs of a SIS3302 module at base address module offset in a loop.

Sequence to load offset of channel N, N=[0,...,7]

dacdata=dacdatum[N]
dacontrol=1 (shift) + N << 4
read dacstatus
until busy==0
dacontrol=2 (load) + N << 4
read dacstatus
until busy==0

Find below a DAC scan that was acquired with the DAC test function of the SIS3302 ADC Labwindows application. The SIS3302 under test was configured for an input span of some $2 V_{pkpk}$. It can be seen, that a DAC offset of some 37000 counts is required to accomplish an input range of -1...+1V on this particular channel.



Note: The actual sample value registers can be used to monitor the influence of the DAC settings on the ADC values.

4.13 Key address general reset

```
#define SIS3302_KEY_RESET 0x400 /* write only; D32 */
```

A write with arbitrary data to this register (key address) resets the SIS3302 to its power up state.

4.14 Key address VME arm sampling logic

```
#define SIS3302_KEY_ARM 0x410 /* write only; D32 */
```

A write with arbitrary data to this register (key address) will arm the sampling logic. If Autostart mode is enabled then the sampling will also start.

4.15 Key address VME disarm sampling logic

```
#define SIS3302_KEY_DISARM 0x414 /* write only; D32 */
```

A write with arbitrary data to this register (key address) will disarm the sampling logic.

4.16 Key address VME start sampling

```
#define SIS3302_KEY_START 0x418 /* write only; D32 */
```

A write with arbitrary data to this register (key address) will initiate if the sampling logic is armed for sampling.

4.17 Key address VME stop sampling

```
#define SIS3302_KEY_STOP 0x41C /* write only; D32 */
```

A write with arbitrary data to this register (key address) will halt sampling on the active page. The Sample Logic will be disarmed also in Single Event Mode or if the Actual_Event_Counter reaches the value of the Max_Nof_Events register.

4.18 Key address Timestamp Clear (0x42C)

```
#define SIS3302_KEY_TIMESTAMP_CLR 0x42C /* write only; D32 */
```

A write with arbitrary data to this register (key address) clears the 48-bit Timestamp counter.

4.19 Event Timestamp directory

```
#define SIS3302_TIMESTAMP_DIRECTORY      0x10000
                                        /* read only; D32, BLT32; size: 0x1000 */
```

The event timestamp directory can be used to measure time between triggers (stops) in multi event mode.

The counter value of the 48-bit wide scaler is written to the corresponding location for subsequent events. It is stored with the last sampled value. To obtain the time of the trigger/stop the information from the sample address bits 0 and 1 of the next sample address register has to be taken into account.

offset address	Timestamp
0x0	Upper Timestamp bits (47:32) of Event 1
0x4	Lower Timestamp bits (31:0) of Event 1
0x8	Upper Timestamp bits (47:32) of Event 2
..	
..	
..	
0xff4	Lower Timestamp bits (31:0) of Event 511
0xff8	Upper Timestamp bits (47:32) of Event 512
0xffc	Lower Timestamp bits (31:0) of Event 512

4.20 Event configuration registers

```
#define SIS3302_EVENT_CONFIG_ALL_ADC      0x01000000 /* write only;D32 */
#define SIS3302_EVENT_CONFIG_ADC12      0x02000000 /* read/write;D32 */
#define SIS3302_EVENT_CONFIG_ADC34      0x02800000 /* read/write;D32 */
#define SIS3302_EVENT_CONFIG_ADC56      0x03000000 /* read/write;D32 */
#define SIS3302_EVENT_CONFIG_ADC78      0x03800000 /* read/write;D32 */
```

This register is implemented for each channel group and it has to be written with the same value, the best way is to make use of the address `SIS3302_EVENT_CONFIG_ALL_ADC` to write to the registers of all channel groups simultaneously.

Bit	Function
31	unused; read 0
...	...
28	unused; read 0
27	unused; read 0
26	unused; read 0
25	FPGA Id. 1
24	FPGA Id. 0
23	unused; read 0
...	...
16	unused; read 0
15	reserved
14	Average Mode Bit 2
13	Average Mode Bit 1
12	Average Mode Bit 0
11	reserved
...	...
8	reserved
7	reserved
6	reserved
5	Enable Event Length Stop mode
4	Enable Page Wrap around mode 0 : Wrap around full memory 1 : Wrap around page until STOP (External or KEY or Event Length Stop)
3	Wrap Page size Bit 3
2	Wrap Page size Bit 2
1	Wrap Page size Bit 1
0	Wrap Page size Bit 0

Enable Event Length Stop mode:

0: no stop from Event Length logic

1: sampling will stop after counts defined in register "Event Length register".

Enable Page Wrap around mode:

0 : Wrap around full memory (32 MSample)

1 : Wrap around in pages defined by pages size bits

The pages size is defined by this register in wrap event mode. The lowest four bits define the number of memory divisions as listed in the table below.

FPGA Id. 0/1:

The two bits are used to identify the ADC/FPGA group as shown in the table below.

ADC/FPGA group	FPGA Id. 1	FPGA Id. 0
ADC78/FPGA3	1	1
ADC56/FPGA2	1	0
ADC34/FPGA1	0	1
ADC12/FPGA0	0	0

4.20.1 Averaging mode

Averaging mode is implemented to improve the signal to noise ratio in lower speed digitization applications. N consecutive samples are summed up in the FPGAs of the dual channel groups

Averaging mode is activated by specifying a non zero value for bits 14:12 of the event configuration register(s).

Average Bit 2	Average Bit 1	Average Bit 0	averaged samples
0	0	0	1 (no average)
0	0	1	2
0	1	0	4
0	1	1	8
1	0	0	16
1	0	1	32
1	1	0	64
1	1	1	128

4.20.2 Wrap Page size

The page/event size is defined by the 4 page size bits as follows:

Page size Bit 3	Page size Bit 2	Page size Bit 1	Page size Bit 0	Page size
0	0	0	0	16 M Samples
0	0	0	1	4 M Samples
0	0	1	0	1 M Samples
0	0	1	1	256 K Samples
0	1	0	0	64K Samples
0	1	0	1	16 K Samples
0	1	1	0	4 K Samples
0	1	1	1	1 K Samples
1	0	0	0	512 Samples
1	0	0	1	256 Samples
1	0	1	0	128 Samples
1	0	1	1	64 Samples
1	1	0	0	reserved
1	1	0	1	reserved
1	1	1	0	reserved
1	1	1	1	reserved

4.21 Event Length register

```
#define SIS3302_SAMPLE_LENGTH_ALL_ADC      0x01000004
#define SIS3302_SAMPLE_LENGTH_ADC12      0x02000004
#define SIS3302_SAMPLE_LENGTH_ADC34      0x02800004
#define SIS3302_SAMPLE_LENGTH_ADC56      0x03000004
#define SIS3302_SAMPLE_LENGTH_ADC78      0x03800004
```

This register defines the number of samples for each event if the “Event Length Stop mode” is enabled.

Value of Event Length register = (Event Length - 4) & 0xffffC

Bit	
31	unused, read as 0
...	
25	unused, read as 0
24	Event Length Register BIT24
..	
2	Event Length Register BIT2
1	Unused
0	Unused

The power up default value is 0

Example: Desired event length 0x100 -> set the register to 0xFC

4.22 Sample Start address register

```
#define SIS3302_SAMPLE_START_ADDRESS_ALL_ADC      0x01000008

#define SIS3302_SAMPLE_START_ADDRESS_ADC12      0x02000008
#define SIS3302_SAMPLE_START_ADDRESS_ADC34      0x02800008
#define SIS3302_SAMPLE_START_ADDRESS_ADC56      0x03000008
#define SIS3302_SAMPLE_START_ADDRESS_ADC78      0x03800008
```

These registers define the memory start address.
The value is given in samples (i.e. number of 16-bit words)

Only Sample Start addresses on a 4 16-bit (sample) boundary (i.e. 8 bytes) are valid.

Bit	
31	unused, read as 0
...	
25	unused, read as 0
24	Sample Start Address Register Bit 24
..	
2	Sample Start Address Register Bit 2
1	unused
0	unused

The power up default value is 0

4.22.1 Explanation (sample start address)

The contents of the start sample register is assigned as memory data storage address with the arm command (key address arm sampling). The user has to distinguish between two the two wrap modes of the SIS3302.

No Page wrap around mode (event configuration register bit 4 = 0):

Bits 24:2 of the sample start register are used as memory start address upon the arm condition. The lowest 2 bits are 0 (i.e. the start address is on a 4 sample or 8 byte boundary). The internal address is incremented by 1 with every sample clock.

The stop will be on a 4 sample boundary.

The next (adjacent) address will be used as the starting point for the next event in multi event mode.

Page wrap around mode (event configuration register bit 4 = 1):

The upper part of the sample start register (page address) is used as memory start address upon the arm command. The lower bits (number of bits defined by the page size, bits 9:0 for a page size of 1K e.g.). The lower portion is incremented by 1 with every sample clock. The stop will be on a 4 sample boundary also. The exact stop location can be obtained from the lowest 2 bits of the next sample register or the event directory.

The upper portion of the address (page address) is incremented by 1 with the start of the next event and the lower portion is cleared again.

4.23 ADC Input mode register

```
#define SIS3302_ADC_INPUT_MODE_ALL_ADC          0x0100000C
#define SIS3302_ADC_INPUT_MODE_ALL_ADC12       0x0200000C
#define SIS3302_ADC_INPUT_MODE_ALL_ADC34       0x0280000C
#define SIS3302_ADC_INPUT_MODE_ALL_ADC56       0x0300000C
#define SIS3302_ADC_INPUT_MODE_ALL_ADC78       0x0380000C
```

This register set is used to generate memory test data.

Bit	Function
31	Unused; read 0
...	...
20	Unused; read 0
19	
18	
17	Test Data 32-bit Mode : 0 = 16-bit mode ; 1 = 32-bit mode
16	Enable Simulate ADC Test Data Mode
15	ADC Test Start Data Bit 15
..	
0	ADC Test Start Data Bit 0

Test Start Data has to be different from 0xYYFE and 0xYYFF.

An increment pattern is recorded in test mode (Bit 16 = 1) instead of real ADC data. Data are incremented by 2 in 32-bit mode.

4.24 ADC1-8 Next Sample address register

```
#define SIS3302_ACTUAL_SAMPLE_ADDRESS_ADC1    0x02000010
#define SIS3302_ACTUAL_SAMPLE_ADDRESS_ADC2    0x02000014
#define SIS3302_ACTUAL_SAMPLE_ADDRESS_ADC3    0x02800010
#define SIS3302_ACTUAL_SAMPLE_ADDRESS_ADC4    0x02800014
#define SIS3302_ACTUAL_SAMPLE_ADDRESS_ADC5    0x03000010
#define SIS3302_ACTUAL_SAMPLE_ADDRESS_ADC6    0x03000014
#define SIS3302_ACTUAL_SAMPLE_ADDRESS_ADC7    0x03800010
#define SIS3302_ACTUAL_SAMPLE_ADDRESS_ADC8    0x03800014
```

These 8 read only registers hold the next sampling address for the given channel.

Bit	Function
31	unused, read as 0
...	
25	unused, read as 0
24	Sample Address Bit 24
..	
2	Sample Address Bit 2
1	Sample Address Bit 1*
0	Sample Address Bit 0*

The power up default value is 0

* Sample address bits 1 and 0 have a dedicated meaning.

Explanation:

Data are stored to memory in packets of 4 consecutive samples by the sample logic. This implies, that either one additional sample is stored in stop mode (wrap mode respective) or that the last 1-2 samples before the stop are not stored.

Sample address bits 1:0 can be used to obtain the position of the stop signal within the 4 sample packet.

The stop delay can be used to make sure, that all samples up to the external stop condition are written to memory.

Sample Address Bits 1:0	Correction
3	- 1
0	0
1	+ 1
2	+ 2

4.25 Actual Sample Value registers

```
#define SIS3302_ACTUAL_SAMPLE_VALUE_ADC12      0x02000020
#define SIS3302_ACTUAL_SAMPLE_VALUE_ADC34      0x02800020
#define SIS3302_ACTUAL_SAMPLE_VALUE_ADC56      0x03000020
#define SIS3302_ACTUAL_SAMPLE_VALUE_ADC78      0x03800020
```

Read “on the fly” of the actual converted ADC values.

The read only registers are updated with every ADC clock, unless a concurrent VME read access is pending.

The register contents is refreshed and can be read any time (i.e. they are updated independent of the unarmed, armed, sampling state) as long as a sampling clock is distributed on the ADC board (internal clock or active/clocking external clock)

ADC 1 / 3 / 5 / 7	ADC 2 / 4 / 6 / 8
D31:16	D15:0
16-bit data	16-bit data

4.26 DDR2 Memory Logic Verification registers

```
#define SIS3302_DDR2_TEST_REGISTER_ADC12      0x02000028
#define SIS3302_DDR2_TEST_REGISTER_ADC34      0x02800028
#define SIS3302_DDR2_TEST_REGISTER_ADC56      0x03000028
#define SIS3302_DDR2_TEST_REGISTER_ADC78      0x03800028
```

ADC 2 / 4 / 6 / 8			
D31:28	D27:24	D23:20	D19:16
Fifo_11_wr_addr	Fifo_10_wr_addr	Fifo_01_wr_addr	Fifo_00_wr_addr

ADC 1 / 3 / 5 / 7			
D15:12	D11:8	D7:4	D3:0
Fifo_11_wr_addr	Fifo_10_wr_addr	Fifo_01_wr_addr	Fifo_00_wr_addr

This register set can be used to verify proper operation of the DDR2 memory read logic. The contents of all registers has to be identical. So far no deviation/error condition with firmware V1.02 has been detected. Please report problems to Struck Innovative Systeme. The error can be salvaged by issuing a key reset DDR2 memory logic command.

4.27 Trigger setup register registers

```
#define SIS3302_TRIGGER_SETUP_ADC1      0x02000030
#define SIS3302_TRIGGER_SETUP_ADC2      0x02000038
#define SIS3302_TRIGGER_SETUP_ADC3      0x02800030
#define SIS3302_TRIGGER_SETUP_ADC4      0x02800038
#define SIS3302_TRIGGER_SETUP_ADC5      0x03000030
#define SIS3302_TRIGGER_SETUP_ADC6      0x03000038
#define SIS3302_TRIGGER_SETUP_ADC7      0x03800030
#define SIS3302_TRIGGER_SETUP_ADC8      0x03800038
```

These read/write registers hold the Peaking and Gap Time of the trapezoidal FIR filter.
(Gap Time = SumG Time – Peaking Time)

Bit	Function	
31	reserved; read 0	
..	..	
24	reserved; read 0	
23	Puls Length bit 7	Trigger Pulse Length
22	Puls Length bit 6	
21	Puls Length bit 5	
20	Puls Length bit 4	
19	Puls Length bit 3	
18	Puls Length bit 2	
17	Puls Length bit 1	
16	Puls Length bit 0	
15	reserved	SumG time (time between both sums)
14	reserved	
13	reserved	
12	SumG bit 4	
11	SumG bit 3	
10	SumG bit 2	
9	SumG bit 1	
8	SumG bit 0	
7	reserved	Peaking time P $x+P$ $\sum_{i=x} S_i$
6	reserved	
5	reserved	
4	P bit 4	
3	P bit 3	
2	P bit 2	
1	P bit 1	
0	P bit 0	

The power up default value reads 0x 00000000

- Si: Sum of ADC input sample stream from x to x+P
- P: Peaking time (number of values to sum)
- SumG: SumGap time (distance in clock ticks of the two running sums)

The maximum SumG time: 16 (clocks)
 The minimum SumG time: 1 (clocks)
 Values > 16 will be set to 16
 Value = 0 will be set to 1

The maximum Peaking time: 16 (clocks)
 The minimum Peaking time: 1 (clocks)
 Values > 16 will be set to 16
 Value = 0 will be set to 1

Note: ADC raw data are shifted 4 bits to the right for trigger formation

4.28 Threshold registers

```

#define SIS3302_TRIGGER_THRESHOLD_ADC1      0x02000034
#define SIS3302_TRIGGER_THRESHOLD_ADC2      0x0200003C
#define SIS3302_TRIGGER_THRESHOLD_ADC3      0x02800034
#define SIS3302_TRIGGER_THRESHOLD_ADC4      0x0280003C
#define SIS3302_TRIGGER_THRESHOLD_ADC5      0x03000034
#define SIS3302_TRIGGER_THRESHOLD_ADC6      0x0300003C
#define SIS3302_TRIGGER_THRESHOLD_ADC7      0x03800034
#define SIS3302_TRIGGER_THRESHOLD_ADC8      0x0380003C

```

These read/write registers hold the threshold values for the ADC channels.

Bit	31-27	26	25	24	16-0
Function	none	Trigger Mode	GT/ GE	LT	Trapezoidal threshold value / threshold value

Trigger Mode = 0 : FIR Filter trigger

Trigger Mode = 1 : Leading edge trigger

4.28.1 Leading edge Trigger

A Trigger Output pulse is generated on two conditions:

1. if LT is set: the Trigger Out Pulse will be issued if the actual ADC value **goes** below the programmable threshold value.
2. if GE is set: the Trigger Out Pulse will be issued if the actual ADC value **goes** above the programmable threshold value - 1

4.28.2 FIR Trigger

The value of the Sum (trapezoidal value) depends on the peaking time P. Therefore the selection of the value of the Trapezoidal threshold depends on P also.
See Trigger Example.

Trapezoidal value calculation:

$$\text{Trapezoidal value} = (\text{SUM2} - \text{SUM1}) + 0x10000$$

Where

$$\text{SUM1} = \sum_{i=x}^{x+P} S_i$$

$$\text{SUM2} = \sum_{j=x+\text{sumG}}^{x+P+\text{sumG}} S_j$$

The FIR Filter logic adds 0x10000 to the result of the subtraction of the two running sums. This implies, that the internal value of the trapezoid is on average 0x10000.

A Trigger Output pulse is generated on two conditions:

1. LT is set: the Trigger Out Pulse will be issued if the actual trapezoidal value **goes** below the programmable trapezoidal threshold value.
2. GT is set: the Trigger Out Pulse will be issued if the actual trapezoidal value **goes** above the programmable trapezoidal threshold value

4.29 Trigger Flag Clear Counter register

```
#define SIS3302_TRIGGER_FLAG_CLR_CNT_ADC12    0x0200002C
#define SIS3302_TRIGGER_FLAG_CLR_CNT_ADC34    0x0280002C
#define SIS3302_TRIGGER_FLAG_CLR_CNT_ADC56    0x0300002C
#define SIS3302_TRIGGER_FLAG_CLR_CNT_ADC78    0x0380002C
```

The Trigger Flag bit is set as soon as an ADC channel meets the trigger criterion. This flag remains latched until the next event start, i.e. it will not be cleared as new ADC data which do not meet the trigger criterion come in with Wrap mode active.

The Trigger Flag Clear Counter register allows you to define a number of 100MHz clocks (NOT sample clock !!) after which the Trigger Flag bit will be cleared unless a new trigger occurred. A counter (for the given ADC channel) is preloaded with the value of the Trigger Flag Clear counter register when the trigger criterion for this channel is met.

The 100 MHz clock will decrement the counter and the Trigger Flag bit will be cleared as soon as the counter reaches 1. If a new trigger occurs before the counter has reached 1, it will be reloaded with the value from the register (retrigger).

Note: typically the user may want to set the value of the Trigger Flag Clear counter register to the memory page size , but this is not mandatory.

The Trigger Flag Clear Logic is disabled if the counter is loaded with 0 (power up default).

Bit	31-0
Function	Trigger Flag Clear counter register

The power up default value is 0

4.30 Event directories

```
#define SIS3302_EVENT_DIRECTORY_ADC1      0x02010000
#define SIS3302_EVENT_DIRECTORY_ADC2      0x02018000
#define SIS3302_EVENT_DIRECTORY_ADC3      0x02810000
#define SIS3302_EVENT_DIRECTORY_ADC4      0x02818000
#define SIS3302_EVENT_DIRECTORY_ADC5      0x03010000
#define SIS3302_EVENT_DIRECTORY_ADC6      0x03018000
#define SIS3302_EVENT_DIRECTORY_ADC7      0x03810000
#define SIS3302_EVENT_DIRECTORY_ADC8      0x03818000
```

The event directories hold the stop pointer(s) (i.e. sample end address+1) of each channel. The directories are 512 words deep and 32 bits wide. A wrap around bit (i.e. bit 28) will be set if the page was filled at least once (i.e. if the memory pointer has reached the end)

Vme offset address	(D31:30)	(D29)	(D28)	(D27:D25)	Event Next Sample Address (D24:D0)
0x0	00	T	W	000	(Next Sample Address) of Event 1
..
0x7fc	00	T	W	000	(Next Sample Address) of Event 512

W: wrap around bit

T: trigger bit

Sample End Address = Next Sample Address - 1

Wrap around bit:

This bit is cleared at start of sampling and it is set when the number of samples reached the value of the Event Length register.

See also "Event Length register".

Trigger bit:

The trigger bit is set with the internal trigger condition is valid.

See also "Trigger Flag Clear Counter register".

See "Next Sample Address Register" for more Information on the Next Sample Address

4.31 ADC memory

```

#define SIS3302_ADC1_OFFSET      0x04000000
#define SIS3302_ADC2_OFFSET      0x04800000
#define SIS3302_ADC3_OFFSET      0x05000000
#define SIS3302_ADC4_OFFSET      0x05800000
#define SIS3302_ADC5_OFFSET      0x06000000
#define SIS3302_ADC6_OFFSET      0x06800000
#define SIS3302_ADC7_OFFSET      0x07000000
#define SIS3302_ADC8_OFFSET      0x07800000

```

The 64 MByte ADC memory per channel can be address in pages of 8 MByte. The page is selected with the ADC Memory page register. One 32-bit word holds 2 ADC samples as shown in the table below.

Data format:

Little Endian Mode: ADC value order big endian mode = 0 (acquisition control register)

VME offset address	D31:16	D15:0
X + 0x0	16-bit data sample N+1	16-bit data sample N
X + 0x4	16-bit data sample N+3	16-bit data sample N+2
X + 0x8	16-bit data sample N+5	16-bit data sample N+4

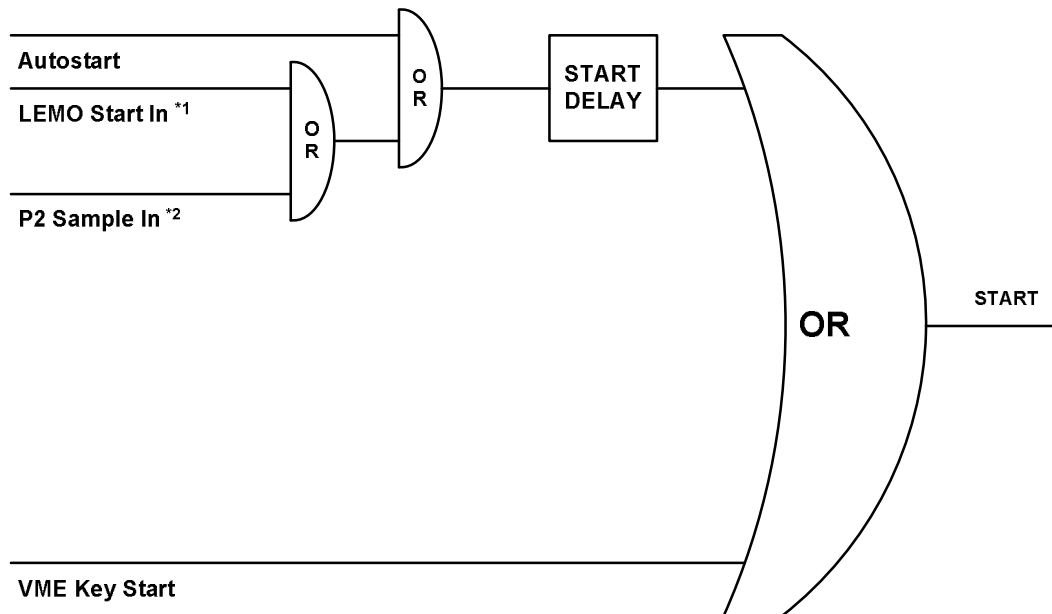
Big Endian Mode: ADC value order big endian mode = 1 (acquisition control register)

VME offset address	D31:16	D15:0
X + 0x0	16-bit data sample N	16-bit data sample N+1
X + 0x4	16-bit data sample N+2	16-bit data sample N+3
X + 0x8	16-bit data sample N+4	16-bit data sample N+5

5 Description of Start/Stop modes of operation

5.1 Start logic summary

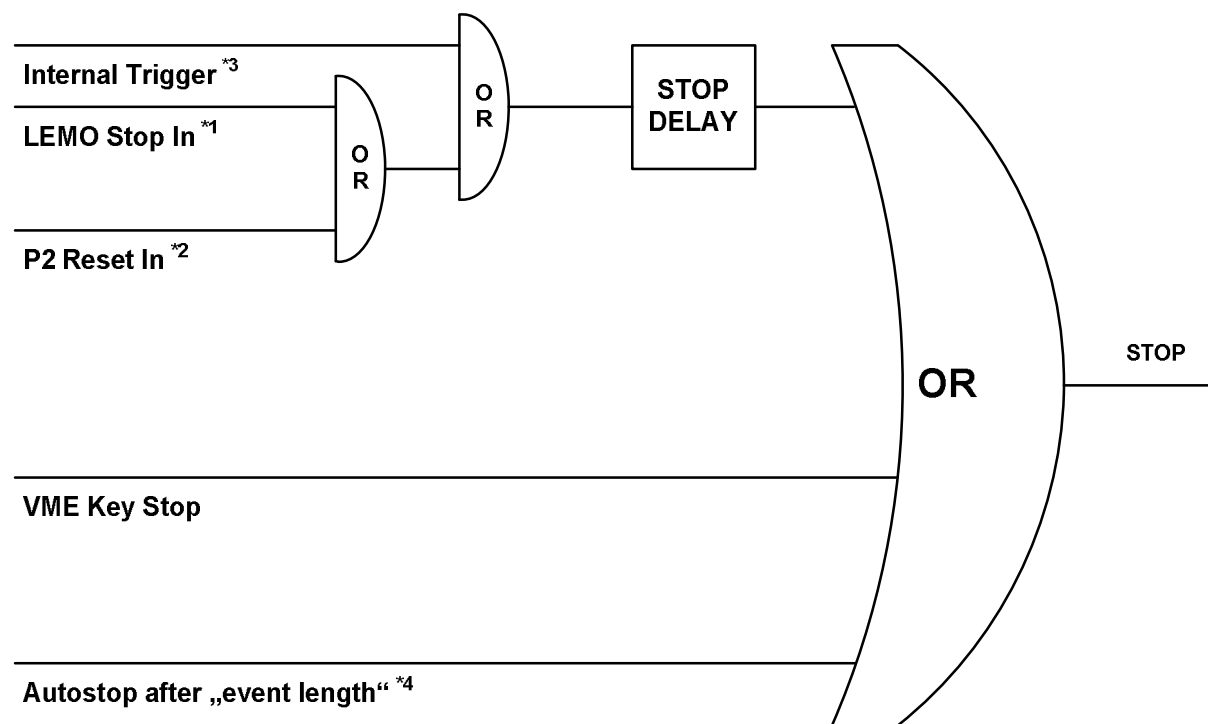
The diagram below illustrates the implemented start conditions of the SIS3302,



Note	Condition	Register	Comment
*1	Bit 8 = 1	Acquisition Control	Enable front panel start/stop logic
*2	Bit 9 = 1	Acquisition Control	not implemented yet (Enable P2 start/stop logic)

5.2 Stop logic summary

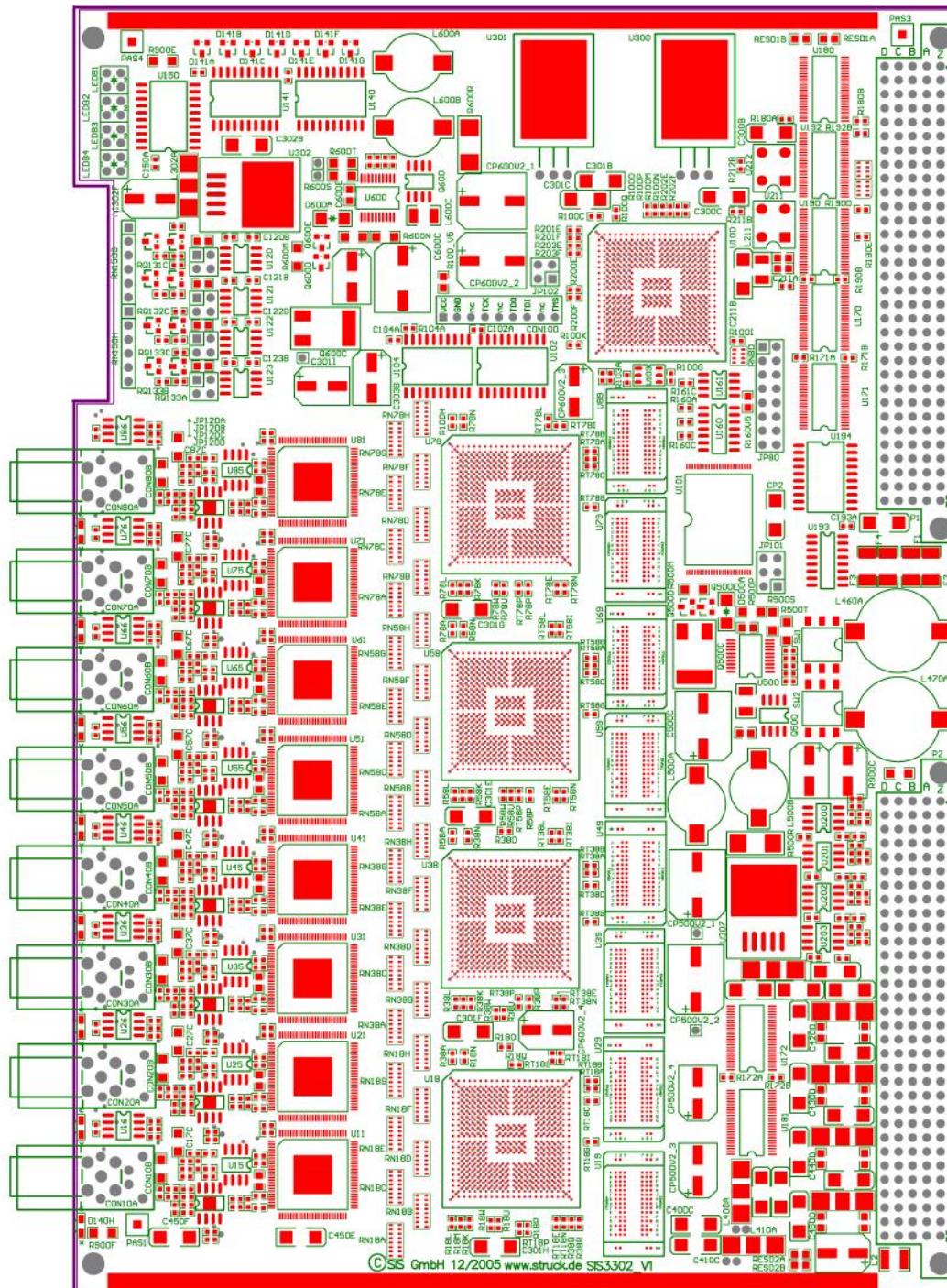
The diagram below illustrates the implemented stop conditions of the SIS3302.



Note	Condition	Register	Comment
*1	Bit 8 = 1	Acquisition Control	Enable front panel start/stop logic
*2	Bit 9 = 1	Acquisition Control	not implemented yet (Enable P2 start/stop logic)
*3	Bit 6 = 1	Acquisition Control	internal trigger as stop
*4	Bit 5 = 1	Event Configuration	Enable Event Length Stop mode

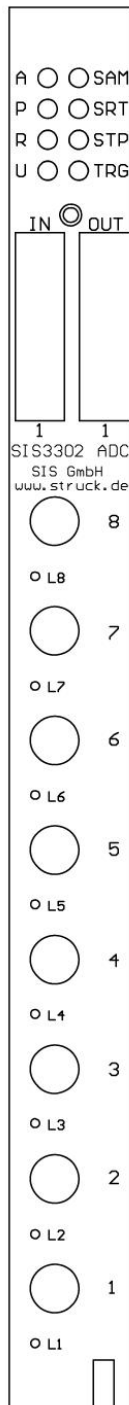
6 Board layout

A printout of the silk screen of the component side of the PCB is shown below.



7 Front panel

The SIS3302 is a single width (4TE) 6U VME module. A sketch of the SIS3302 front panel (single ended LEMO00 version without handles) is shown below. The IN/OUT breakouts hold 4 LEMO connectors each.



7.1 Control In/Outputs

The control I/O section features 8 LEMO00 connectors with NIM levels.

Designation	Inputs	Outputs	Designation
4	Clock In	Clock Out	4
3	Start	Ready for start (ADC sample logic armed)	3
2	Stop	Ready for stop (ADC sampling busy)	2
1	Timestamp Clear	Trigger output	1

The ready for start and ready for stop outputs can be used to interfere with external deadtime logic. Ready for start will become active as soon as the sample logic is armed. Ready for stop will go active as soon as the start signal was seen by the module.

The external clock must be a symmetric signal unless the module is operated in external random clock mode

The width of an external start/stop pulse must be greater or equal two sampling clock periods.

7.2 LED's

The SIS3302 has 8 front panel LEDs to visualise part of the modules status. The user (and access) LED are a good way to check first time communication/addressing with the module.

Color	Designator	Function
Yellow	A	Access to SIS3302 VME slave port
Red	P	Power
Green	R	Ready, on board logic configured
Green	U	User, to be set/cleared under program control
Yellow	SAM	Sampling busy
Red	SRT	Lit if the lower Timestamp counter bits 27 to 0 are equal to 0x0FFFFFFF (or of all four timestamp counters) . (100 MHz clock -> lit every 2.6 sec)
Green	STP	Stop, lit with stop input
Green	TRG	Trigger, lit if one or more channels are above threshold

The on duration of the access, sampling, start, stop and trigger LEDs is stretched to guarantee visibility even under low rate conditions.

7.3 Channel LED's

The 8 card edge surface mounted LEDs L1, ..., L8 can be seen through the corresponding holes in the front panel. They visualize the trigger status of the corresponding channel. The on duration is stretched for better visibility of short pulses.

7.4 PCB LEDs

The 8 surface mounted red LEDs D141A to D141G on the top left corner of the component side of the SIS3302 are routed to the control FPGA, their use may depend on the firmware design.

8 Jumpers/Configuration

8.1 CON100 JTAG

The SIS3302 on board logic can load its firmware from a serial PROMs , via the JTAG port on connector CON100 or over VME. A list of firmware designs can be found under <http://www.struck.de/sis3302firm.htm>.

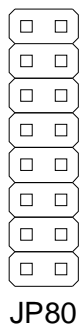
Hardware like the XILINX HW-JTAG-PC in connection with the appropriate software will be required for in field JTAG firmware upgrades. The JTAG chain configuration is selected with jumper JP101, jumper JP102 is used to chose VME or CON100 as JTAG source.

The JTAG connector is a 9 pin single row 1/10 inch header, the pin assignment on the connector can be found in the table below.

Pin	Short hand	Description
1	VCC	Supply voltage
2	GND	Ground
3	nc	not connected, cut to avoid polarity mismatch
4	TCK	test clock
5	nc	not connected
6	TDO	test data out
7	TDI	test data in
8	nc	not connected
9	TMS	test modus

8.2 JP80 VME addressing mode/reset behaviour

This 8 position jumper array is used to select the addressing mode and the reset behaviour of the SIS3302.



Pos	Function	Factory default
1	A32	closed
2	A16 (not supported)	open
3	GEO (not supported)	open
4	VIPA (not supported)	open
5	connect VME SYSRESET IN to FPGA reset	closed
6	connect watchdog to VME SYSRESET OUT	open
7	connect FPGA reset VME SYSRESET OUT	open
8	connect VME SYSRESET to board reset	closed

The enable watchdog jumper has to be removed during (initial) JTAG firmware load.

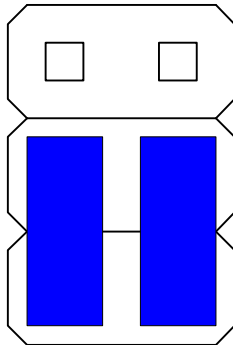
NOTE: avoid a power up deadlock situation by not setting Pos. 5 and 7 at the same time

8.3 JP101 JTAG chain

The JTAG chain on the SIS3302 can be configured to comprise the serial PROM only (short JTAG chain) or to comprise the serial PROM and the 5 Spartan III FPGAs (long chain). The configuration is selected with the 6-pin array JP101 as sketched below:

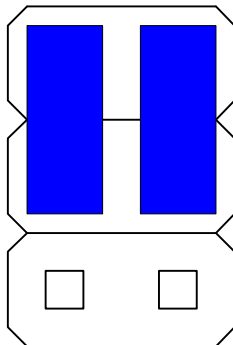
Long Chain (1-3 and 2-4 closed):

JP101



Short Chain (3-5 and 4-6 closed, factory default):

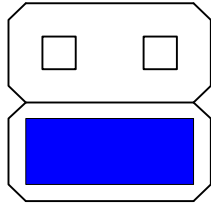
JP101



8.4 JP102 JTAG source

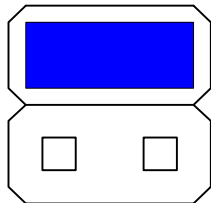
The JTAG chain can be connected to VME or to the JTAG connector CON...via the 4 pin jumper array JP102 as sketched below:

JTAG connected to VME (1-2 closed)



JP102

JTAG connected to connector CON100 (3-4 closed, factory default)

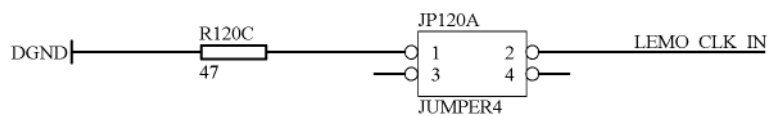


JP102

8.5 JP120A-JP120D control input termination

The contact pair 1-2 of these 4 jumper arrays is used to connect the termination resistor to the 4 control inputs as illustrated with the schematic for JP120A below.

Jumper	Control Input	Factory Default
JP120A	Clock In	Closed
JP120B	Start In	Closed
JP120C	Stop In	Closed
JP120D	User In	Closed



8.6 SW1 and SW2, VME base address

These 2 rotary switches are used to define 2 nibbles of the VME base address in non geographical addressing (refer to section base address also).

Switch	Function
SW1	ADR_LO
SW2	ADR_UP

9 Getting started

The directory `sis3302\software\win` of the Struck Innovative Systeme CDROM holds example code for National Instruments Labwindows CVI. The source code can be used as a base for ports to other environments. The VisualC++ examples from the `sis3320` can be used for the `sis3302` due to the similar architecture.

The `sis3302.h` header file can be found in the directory `sis3302\software`.

The routine `ConfigurationSetupAdc(void)` in the file `sis3302_adc_test1.c` (CVI directory) can be used as starting point for a setup routine for the `SIS3302`.

10 Appendix

10.1 Power consumption

The SIS3302 uses standard VME voltages only.

Voltage	Current
+ 5V	8A
+12 V	115 mA
- 12 V	340 mA

10.2 Operating conditions

10.2.1 Cooling

Although the SIS3302 is mainly a 2.5 and 3.3 V design, substantial power is consumed by the Analog to Digital converter chips and linear regulators however. Hence forced air flow is required for the operation of the board. An air capacity in excess of 160 m³/h is required. Unoccupied adjacent slots of the VME crate have to be equipped with filler modules to ensure proper air flow. The board may be operated in a non condensing environment at an ambient temperature between 10 and 25 Celsius. A power up warm up time of some 10 minutes is recommended to ensure equilibrium on board temperature conditions.

10.2.2 Hot swap/live insertion

Please note, that the VME standard does not support hot swap by default. The SIS3302 is configured for hot swap in conjunction with a VME64x backplane. In non VME64x backplane environments the crate has to be powered down for module insertion and removal.

10.3 Connector types

The VME connectors and the different types of front panel connectors used on the SIS3302 are:

Connector	Purpose	Part Number
160 pin zabcd	VME P1/P2	Harting 02 01 160 2101
LEMO PCB	Coax. control connector	LEMO EPB.00.250.NTN
90° PCB LEMO	Analog input connector	LEMO EPL.00.250.NTN
90° PCB	Analog input connector (SMA option)	SMA
90° PCB LEMO	Analog input connector (3302 differential input version)	LEMO EPL.0S.302.HLN

10.4 P2 row A/C pin assignments

The P2 connector of the SIS3302 has several connections on rows A and C for the F1002 compatible use at the DESY H1 FNC subdetector. This implies, that the module can not be operated in a VME slot with a special A/C backplane, like VSB e.g.. The pin assignments of P2 rows A/C of the SIS3302 is shown below:

P2A	Function	P2C	Function
1	-5.2 V	1	-5.2 V
2	-5.2 V	2	-5.2 V
3	-5.2 V	3	-5.2 V
4	not connected	4	not connected
5	not connected	5	not connected
6	DGND	6	DGND
7	P2_CLOCK_H	7	P2_CLOCK_L
8	DGND	8	DGND
9	P2_START_H	9	P2_START_L
10	P2_STOP_H	10	P2_STOP_L
11	P2_TEST_H	11	P2_TEST_L
12	DGND	12	DGND
13	DGND	13	DGND
14	DGND	14	DGND
15	DGND	15	DGND
16	not connected	16	not connected
...	...	17	...
31	not connected	18	not connected

Note: The P2 ECL signals are bussed and terminated on the backplane of F1002 crates. The user has to insure proper termination if a cable backplane or add on backplane is used.

10.5 Row d and z Pin Assignments

The SIS3302 is prepared for the use with VME64x and VME64xP backplanes. Foreseen features include geographical addressing (PCB revisions V2 and higher) and live insertion (hot swap). The prepared pins on the d and z rows of the P1 and P2 connectors are listed below.

Position	P1/J1		P2/J2	
	Row z	Row d	Row z	Row d
1		VPC (1)		
2	GND	GND (1)	GND	
3				
4	GND		GND	
5				
6	GND		GND	
7				
8	GND		GND	
9		GAP*		
10	GND	GA0*	GND	
11	RESP*	GA1*		
12	GND		GND	
13		GA2*		
14	GND		GND	
15		GA3*		
16	GND		GND	
17		GA4*		
18	GND		GND	
19				
20	GND		GND	
21				
22	GND		GND	
23				
24	GND		GND	
25				
26	GND		GND	
27				
28	GND		GND	
29				
30	GND		GND	
31		GND (1)		GND (1)
32	GND	VPC (1)	GND	VPC (1)

Note: Pins designated with (1) are so called MFBL (mate first-break last) pins on the installed 160 pin connectors, VPC(1) pins are connected via inductors.

10.6 Firmware upgrade

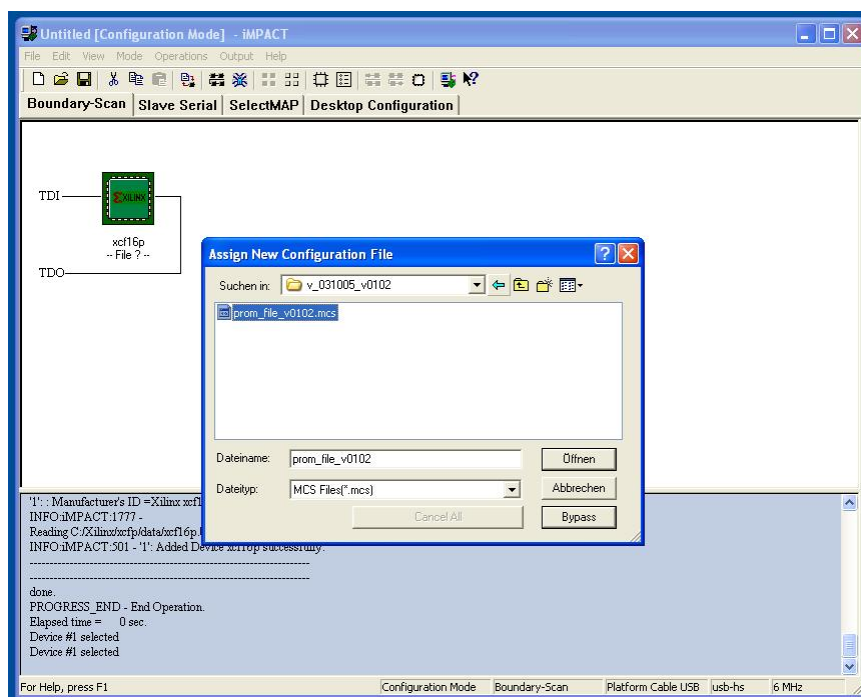
The firmware of the SIS3302 can be upgraded over JTAG. The upgrade options are VME (on units that have intact firmware) and the JTAG connector CON100.

10.6.1 Upgrade over CON100

The firmware can be upgraded with the Xilinx Impact software, which is part of the Webpack that can be downloaded from the Xilinx web page for free. A version of the Webpack software (which may not be up to date and not compatible with your JTAG hardware) can be found in the xilinx_webpack directory of the Struck Innovative Systeme CDROM also. A Xilinx JTAG parallel cable or USB (Xilinx part number HW-USB) cable can be used to roll in the firmware.

Configure the SIS3302 for short JTAG chain (refer to section 8.3 JP101) and set the unit to JTAG over CON100 (refer to section 8.4 JP102 JTAG source).

With your hard- and software properly set up you should see a screen as illustrated below after executing the initialize chain command.



Load the mcs file to the serial PROM (shown as xcf16p).

10.6.2 Upgrade over VME

The directories

```
sis3150usb\Driver_Software\Windows\sis3150usb_vme_applications\  
visualC_applications\Xilinx_Jtag_Programing\sis3320_xilinx_jtag  
and
```

```
sis1100_3100_win2k\VisualC_applications\Xilinx_Jtag_Programing  
\sis3320_xilinx_jtag
```

holds example code for VisualC++.

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